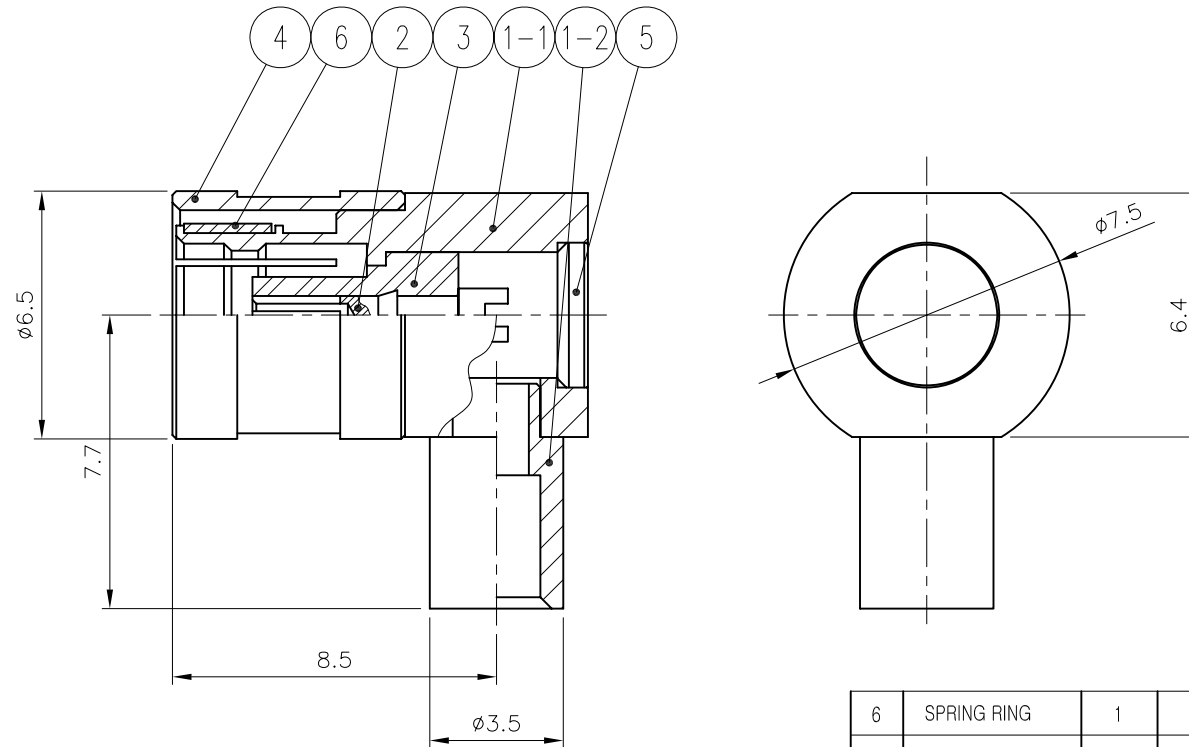


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2013.03.14.



6	SPRING RING	1	BeCu	Nickel Plate	DSR00004-5/2
5	COVER	1	MBsBD	Nickel Plate	DCO00013-5/3
4	CAP	1	MBsBD	Nickel Plate	DCU00024-5/2
3	INSULATOR	1	TEFLON		DIN00327-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT00365-5/1
1	1-2 BODY (B)	1	MBsBD	Nickel Plate	DBD01322-1/1
	1-1 BODY (A)	1	MBsBD		DBD00461-3/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 03. 14.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.H.KIM	TITLE SMB50 CABLE PL 85TP(50Ω) Solder
		DRAWN BY	I.C.KIM	
FINISH		SCALE	5/1	A4 DWG NO. CN00202-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	